CH03-BE - SIM CARD HOLDER WITH SWITCH 6 OR 8 PINS

FEATURES

1. GENERAL CHARACTERISTICS
   DALLENG: 29.65L x 17.20W x 3.00H mm
   WEIGHT: APPROX. 1.43g
   CONTACT PRINCIPLE: FRICTION TECHNOLOGY
   OPERATING POSITIONS: SHAFT UP / DOWN / HORIZONTAL
   MOUNTING SYSTEM: SMT TYPE (post optional)
   DURABILITY: 10,000 CYCLES MIN.

2. MECHANICAL CHARACTERISTICS
   INSULATION MATERIAL: THERMOPLASTIC, UL 94V-O
   FLATING GOLD FLASH ON CONTACT AREA/TIN ON SOLDER TAIL

3. ELECTRICAL CHARACTERISTICS
   CONTACT RESISTANCE: <50m OHMS MAX.
   INSULATION RESISTANCE: >1000M OHMS / 500V DC
   SWITCH TYPE: BLADE (Normally Open)
   RATED CURRENT: 1A MAX.
   RATED VOLTAGE: 50V MAX.
   WITHSTANDING DIELECTRIC VOLTAGE: 500V AC RMS, FOR 1 MINUTE

4. SOLDERABILITY
   WAVE: NOT APPLICABLE
   IR REFLOW: 260°C, 10 SEC. MAX.
   MANUAL SOLDERING: 360°C, 3 SEC. MAX.

5. ENVIRONMENTAL CHARACTERISTICS
   OPERATING TEMPERATURE: -40°C ~ +85°C
   OPERATING HUMIDITY: 10% ~ 95% RH
   STORAGE TEMPERATURE: -40°C ~ +85°C
   STORAGE HUMIDITY: 10% ~ 95% RH

NOTES:
1. ACCEPTABLE SIM CARD SIZE SHOULD MEET GSM 11.11 SPECIFICATION
   REQUIREMENT.

HOW TO ORDER

CH03  -  BEX00  -  0XR

NO. OF CONTACTS
06 OR 08

WITH OR WITHOUT LOCATING FEG
A = WITH
B = WITHOUT

PACKAGING OPTIONS
R = REEL
600PCS/REEL

PCB FOOTPRINT COMPONENT SIDE
REEL CENTER WITH 7 EMPTY CARRIER

WITH 17 EMPTY CARRIER AT FRONT END

168mm
1440mm
408mm
160mm

32mm
350mm
320mm

NOTES:
1. REEL DIA 130MM
2. 600PCS PER REEL, GROSS WEIGHT: 139KG
3. 6 REELS PER FULL CARTON, GROSS WEIGHT: 934KG